10 x 3.2 x 4.0 mm Ceramic Chip Antenna (On Ground type, Top surface ground removal area 10.80 x 6.25 mm). Pulse Part Number: W3001



#### Features

- Omni directional radiation (Azimuthal plane)
- Low profile
- Compact size W x L x H (10 x 3.2 x 4 mm)
- Low weight (600 mg)
- Lead free materials
- Fully SMD compatible
- Lead free soldering compatible
- Tape and reel packing
- RoHS compliant product

#### **Applications**

- Bluetooth
- 2.4 GHz WLAN
- 2.4 GHz ISM Band System

Electrical specifications @ +25 °C

Note: Electrical characteristics depend on test board (GP) size and antenna positioning on GP and Ground Clearance area size.

#### WiFi 2.4 GHz

Typical performance

(Test board size 80 x 37 mm, PWB top surface ground removal area 10.80 x 6.25 mm, position 1 on PWB)

Freq	uency Range	Max Gain	Efficiency	Return loss	Impedance	Operating
	[MHz]	[dBi]	[%] / [dB]	min. [dB]	[Ω]	Temperature [° C]
240	00 – 2483.5	1.5 (Peak) 0.5 (Band edges)	75 /-1.25 (Peak) 60/-2.25 (Band edges)	-6	50	-45 to +85

Pulse Finland Oy Takatie 6 90440 Kempele, Finland Tel: +358 207 935 500 Fax: +358 207 935 501 www.pulseeng.com/antennas



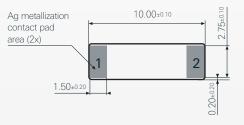
10 x 3.2 x 4.0 mm Ceramic Chip Antenna (On Ground type, Top surface ground removal area 10.80 x 6.25 mm). Pulse Part Number: W3001

#### **Terminal Configuration and Dimensions**

On Ground type, Top surface ground removal area 10.80 x 6.25 mm

#### Antenna features

No.	Terminal name	Terminal Dimensions		
1	Feed / GND	1.5 x 2.75 mm		
2	Feed / GND	1.5 x 2.75 mm		



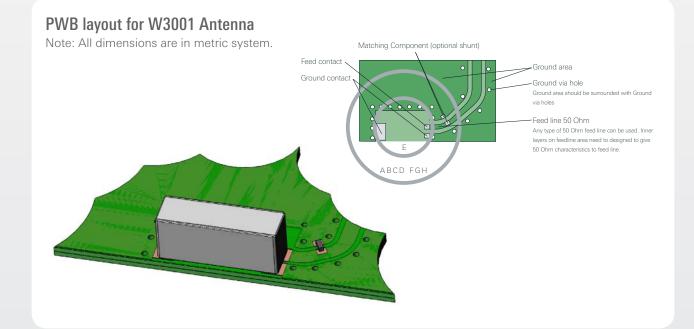
Antenna is symmetrical.

Either of terminals 1 or 2 can be feed / GND

### **Antenna PWB Layout Specifications**

On Ground type, Top surface ground removal area 10.80 x 6.25 mm

Matching and tuning component values depend on application and surrounding mechanics / materials. Feed line should be designed to match 50  $\Omega$  characteristic impedance, depending on PWB material and thickness. Recommended test board layout for electrical characteristic measurement, test board outline size 80 x 37 mm.

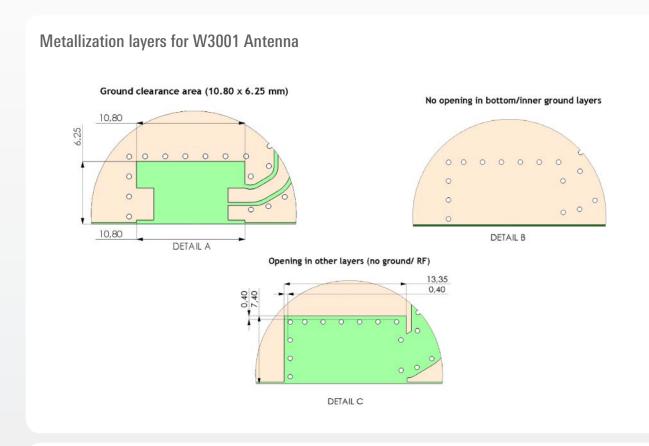


Pulse Finland Oy Takatie 6 90440 Kempele, Finland Tel: +358 207 935 500 Fax: +358 207 935 501 www.pulseeng.com/antennas

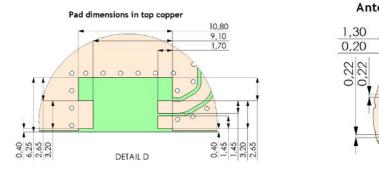
Downloaded from Arrow.com.



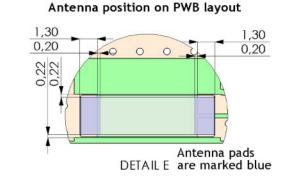
10 x 3.2 x 4.0 mm Ceramic Chip Antenna (On Ground type, Top surface ground removal area 10.80 x 6.25 mm). Pulse Part Number: W3001



### PWB pad dimensions and antenna position for W3001 Antenna



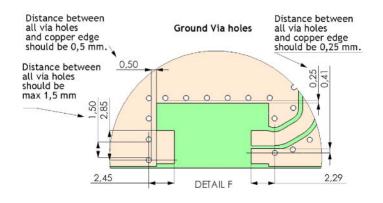
Pulse Finland Oy Takatie 6 90440 Kempele, Finland Tel: +358 207 935 500 Fax: +358 207 935 501 www.pulseeng.com/antennas



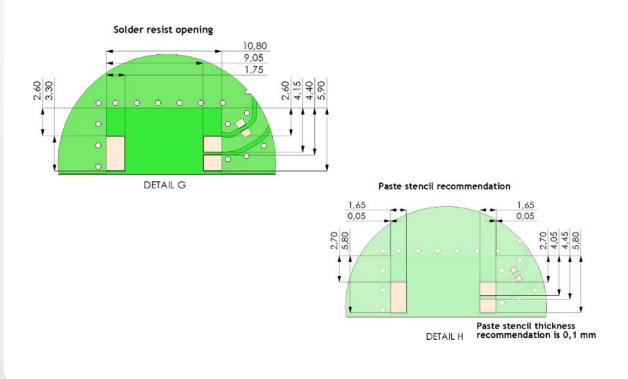


10 x 3.2 x 4.0 mm Ceramic Chip Antenna (On Ground type, Top surface ground removal area 10.80 x 6.25 mm). Pulse Part Number: W3001

Typical ground via hole placement in PWB layout for W3001 Antenna



Solder resist opening and Paste stencil recommendation for W3001 Antenna



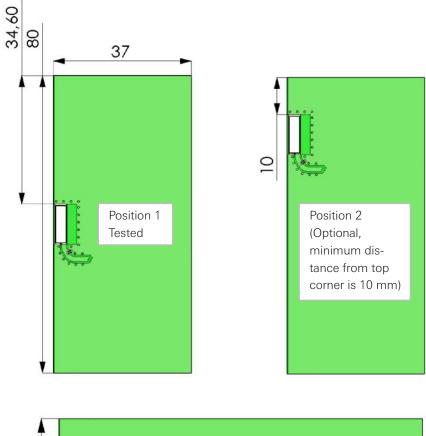
Pulse Finland Oy Takatie 6 90440 Kempele, Finland Tel: +358 207 935 500 Fax: +358 207 935 501 www.pulseeng.com/antennas

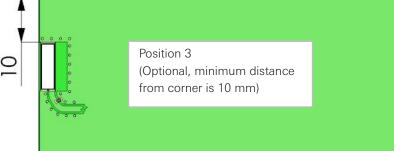


10 x 3.2 x 4.0 mm Ceramic Chip Antenna (On Ground type, Top surface ground removal area 10.80 x 6.25 mm). Pulse Part Number: W3001

### Recommended antenna position on PWB for W3001 Antenna

Our test PWB size is  $37 \times 80$  mm, other sized boards can be used depending on customer device size (minimum  $35 \times 35$  mm).





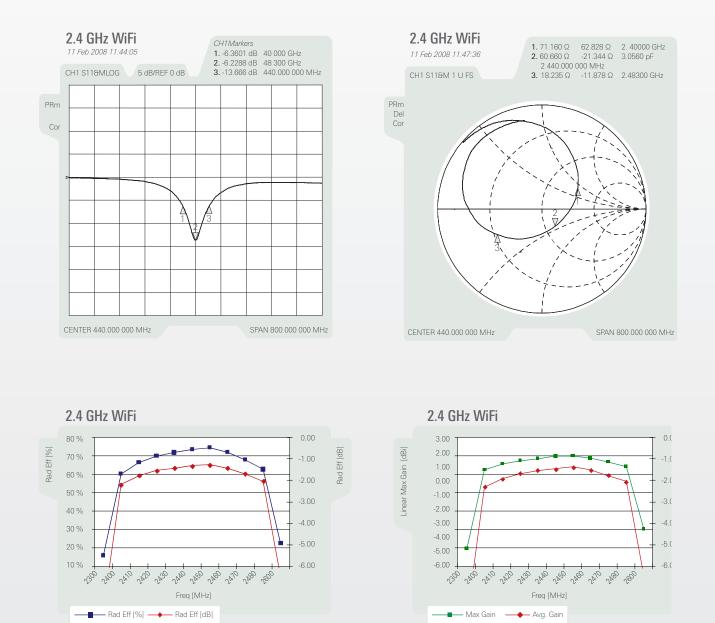
Pulse Finland Oy Takatie 6 90440 Kempele, Finland Tel: +358 207 935 500 Fax: +358 207 935 501 www.pulseeng.com/antennas



10 x 3.2 x 4.0 mm Ceramic Chip Antenna (On Ground type, Top surface ground removal area 10.80 x 6.25 mm). Pulse Part Number: W3001

#### Typical Electrical Characteristics (T=25 °C)

Measured on the 80 x 37 mm test board with matching circuit (1.2 pF shunt matching capacitor on feed). Measured in antenna position 1 on PWB layout, see previous page.

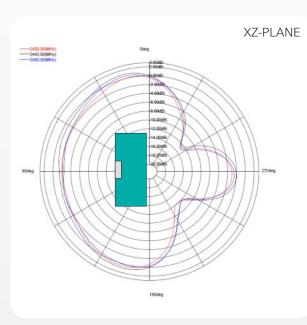


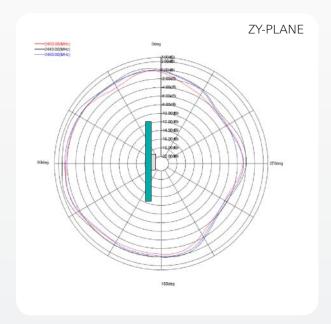
Pulse Finland Oy Takatie 6 90440 Kempele, Finland Tel: +358 207 935 500 Fax: +358 207 935 501 www.pulseeng.com/antennas

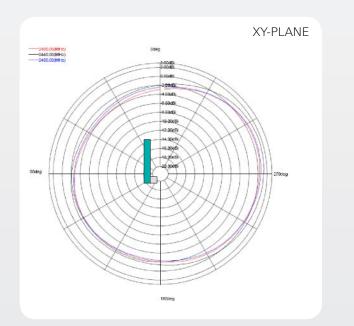


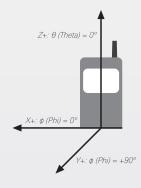
10 x 3.2 x 4.0 mm Ceramic Chip Antenna (On Ground type, Top surface ground removal area 10.80 x 6.25 mm). Pulse Part Number: W3001

#### Typical Free Space Radiation Patterns











Pulse Finland Oy Takatie 6 90440 Kempele, Finland Tel: +358 207 935 500 Fax: +358 207 935 501 www.pulseeng.com/antennas

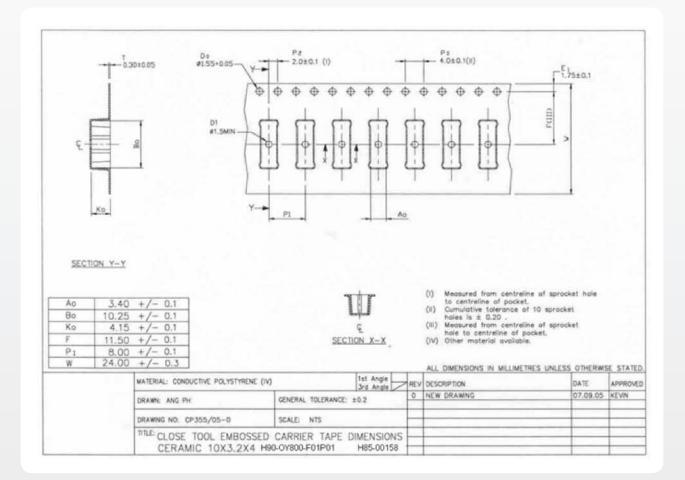


10 x 3.2 x 4.0 mm Ceramic Chip Antenna (On Ground type, Top surface ground removal area 10.80 x 6.25 mm). Pulse Part Number: W3001

#### Packing

Tape and reel packing is used. Carrier tape, reel and box dimensions are presented in following pictures.

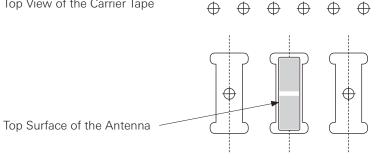
### **Carrier Tape**



### **Block Orientation**

Antenna soldering pads facing down to the bottom of the carrier tape.

Top View of the Carrier Tape

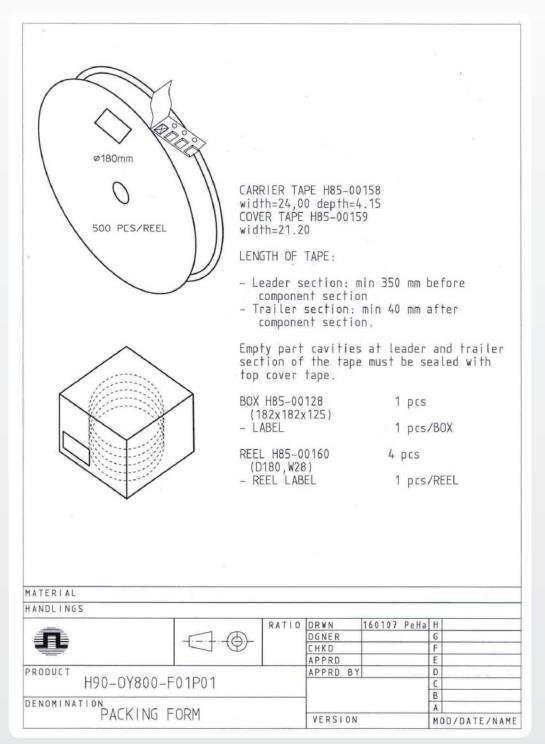


Pulse Finland Oy Takatie 6 90440 Kempele, Finland Tel: +358 207 935 500 Fax: +358 207 935 501 www.pulseeng.com/antennas



10 x 3.2 x 4.0 mm Ceramic Chip Antenna (On Ground type, Top surface ground removal area 10.80 x 6.25 mm). Pulse Part Number: W3001

#### **Packing Form**



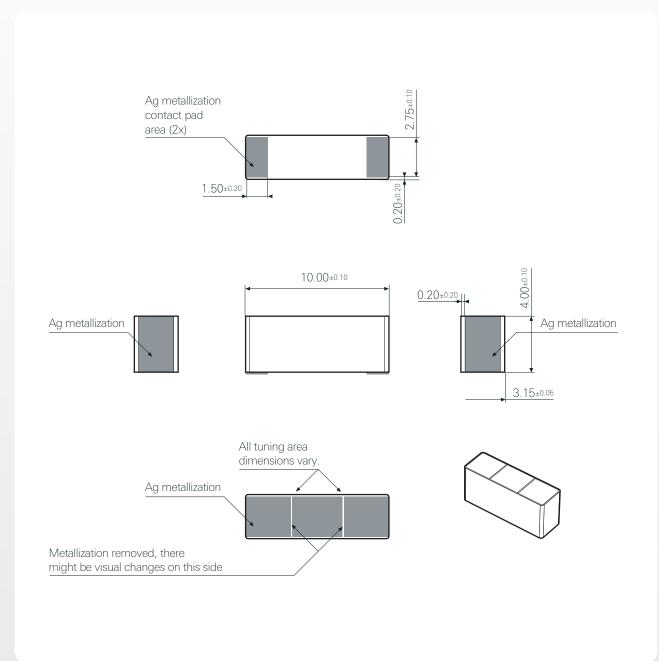
Pulse Finland Oy Takatie 6 90440 Kempele, Finland Tel: +358 207 935 500 Fax: +358 207 935 501 www.pulseeng.com/antennas



Downloaded from Arrow.com.

10 x 3.2 x 4.0 mm Ceramic Chip Antenna (On Ground type, Top surface ground removal area 10.80 x 6.25 mm). Pulse Part Number: W3001

### **Mechanical Outline**







© 2008. All Rights Reserved.

Downloaded from Arrow.com.